

Field Stop Trench IGBT

50 A, 650 V

AFGHL50T65SQ

Using the novel field stop 4th generation high speed IGBT technology. AFGHL50T65SQ which is AEC Q101 qualified offers the optimum performance for both hard and soft switching topology in automotive application. It is a stand-alone IGBT.

Features

- AEC-Q101 Qualified
- Maximum Junction Temperature: $T_J = 175^\circ\text{C}$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.6\text{ V (Typ.) @ } I_C = 50\text{ A}$
- 100% of the Parts are Tested for I_{LM} (Note 2)
- Fast Switching
- Tight Parameter Distribution
- RoHS Compliant

Typical Applications

- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters
- Totem Pole Bridgeless PFC
- PTC

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-to-Emitter Voltage	V_{CES}	650	V
Gate-to-Emitter Voltage Transient Gate-to-Emitter Voltage	V_{GES}	± 20 ± 30	V
Collector Current (Note 1)	I_C	80 50	A
		@ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	
Pulsed Collector Current (Note 2)	I_{LM}	200	A
Pulsed Collector Current (Note 3)	I_{CM}	200	A
Maximum Power Dissipation	P_D	268 134	W
		@ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	
Operating Junction / Storage Temperature Range	T_J, T_{STG}	-55 to +175	$^\circ\text{C}$
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

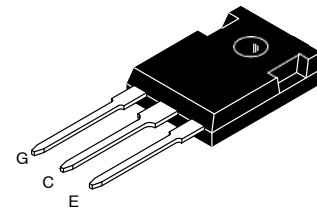
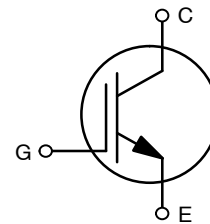
1. Value limit by bond wire
2. $V_{CC} = 400\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 200\text{ A}$, $R_G = 15\ \Omega$, Inductive Load
3. Repetitive Rating: pulse width limited by max. Junction temperature



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50 A, 650 V
 $V_{CESat} = 1.6\text{ V}$



TO-247-3L
CASE 340CX

MARKING DIAGRAM



&Z = Assembly Plant Code
&3 = 3-Digit Date Code
&K = 2-Digit Lot Traceability Code
AFGHL50T65SQ = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
AFGHL50T65SQ	TO-247-3L	30 Units / Rail

AFGHL50T65SQ

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{\theta JC}$	0.56	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0\text{ V},$ $I_C = 1\text{ mA}$	BV_{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0\text{ V},$ $I_C = 1\text{ mA}$	$\frac{\Delta BV_{CES}}{\Delta T_J}$	-	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	$V_{GE} = 0\text{ V},$ $V_{CE} = 650\text{ V}$	I_{CES}	-	-	250	μA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20\text{ V},$ $V_{CE} = 0\text{ V}$	I_{GES}	-	-	±400	nA

ON CHARACTERISTICS

Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 50\text{ mA}$	$V_{GE(th)}$	3.4	4.9	6.4	V
Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 50\text{ A}$ $V_{GE} = 15\text{ V}, I_C = 50\text{ A}, T_J = 175^\circ\text{C}$	$V_{CE(sat)}$	-	1.6	2.1	V
			-	1.95	-	

DYNAMIC CHARACTERISTICS

Input capacitance	$V_{CE} = 30\text{ V},$ $V_{GE} = 0\text{ V},$ $f = 1\text{ MHz}$	C_{ies}	-	3209	-	pF
Output capacitance		C_{oes}	-	42	-	
Reverse transfer capacitance		C_{res}	-	12	-	
Gate charge total	$V_{CE} = 400\text{ V},$ $I_C = 50\text{ A},$ $V_{GE} = 15\text{ V}$	Q_g	-	99	-	nC
Gate-to-emitter charge		Q_{ge}	-	17	-	
Gate-to-collector charge		Q_{gc}	-	23	-	

SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Turn-on delay time	$T_C = 25^\circ\text{C},$ $V_{CC} = 400\text{ V},$ $I_C = 25\text{ A},$ $R_G = 4.7\ \Omega,$ $V_{GE} = 15\text{ V},$ Inductive Load, FWD: AFGHL50T65SQD	$t_{d(on)}$	-	19	-	ns
Rise time		t_r	-	11	-	
Turn-off delay time		$t_{d(off)}$	-	87	-	
Fall time		t_f	-	5	-	
Turn-on switching loss		E_{on}	-	0.35	-	mJ
Turn-off switching loss		E_{off}	-	0.12	-	
Total switching loss		E_{ts}	-	0.47	-	
Turn-on delay time	$T_C = 25^\circ\text{C},$ $V_{CC} = 400\text{ V},$ $I_C = 50\text{ A},$ $R_G = 4.7\ \Omega,$ $V_{GE} = 15\text{ V},$ Inductive Load, FWD: AFGHL50T65SQD	$t_{d(on)}$	-	20	-	ns
Rise time		t_r	-	28	-	
Turn-off delay time		$t_{d(off)}$	-	81	-	
Fall time		t_f	-	36	-	
Turn-on switching loss		E_{on}	-	0.95	-	mJ
Turn-off switching loss		E_{off}	-	0.46	-	
Total switching loss		E_{ts}	-	1.41	-	

AFGHL50T65SQ

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Turn-on delay time	$T_J = 175^\circ\text{C}$, $V_{CC} = 400\text{ V}$, $I_C = 25\text{ A}$, $R_G = 4.7\ \Omega$, $V_{GE} = 15\text{ V}$, Inductive Load, FWD: AFGHL50T65SQD	$t_{d(on)}$	-	18	-	ns
Rise time		t_r	-	14	-	
Turn-off delay time		$t_{d(off)}$	-	99	-	
Fall time		t_f	-	7	-	
Turn-on switching loss		E_{on}	-	0.66	-	mJ
Turn-off switching loss		E_{off}	-	0.3	-	
Total switching loss		E_{ts}	-	0.96	-	
Turn-on delay time	$T_J = 175^\circ\text{C}$, $V_{CC} = 400\text{ V}$, $I_C = 50\text{ A}$, $R_G = 4.7\ \Omega$, $V_{GE} = 15\text{ V}$, Inductive Load, FWD: AFGHL50T65SQD	$t_{d(on)}$	-	20	-	ns
Rise time		t_r	-	29	-	
Turn-off delay time		$t_{d(off)}$	-	88	-	
Fall time		t_f	-	46	-	
Turn-on switching loss		E_{on}	-	1.42	-	mJ
Turn-off switching loss		E_{off}	-	0.65	-	
Total switching loss		E_{ts}	-	2.07	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AFGHL50T65SQ

TYPICAL CHARACTERISTICS

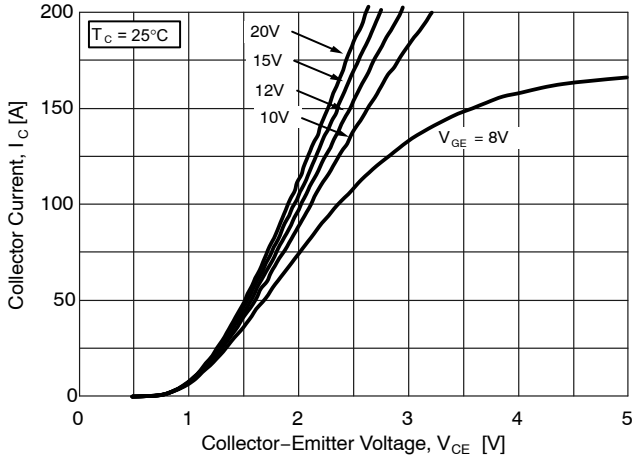


Figure 1. Typical Output Characteristics

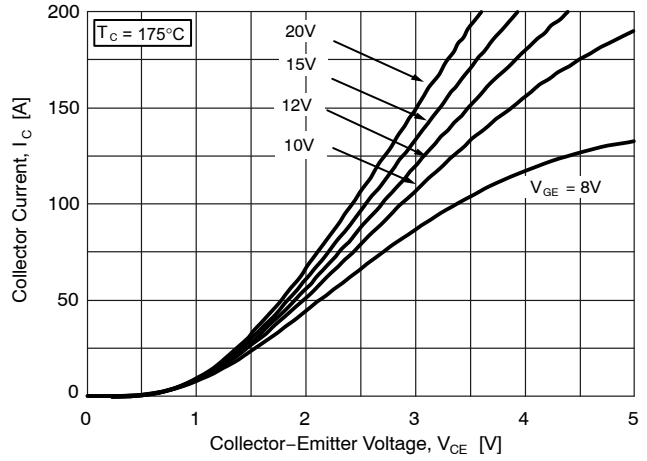


Figure 2. Typical Output Characteristics

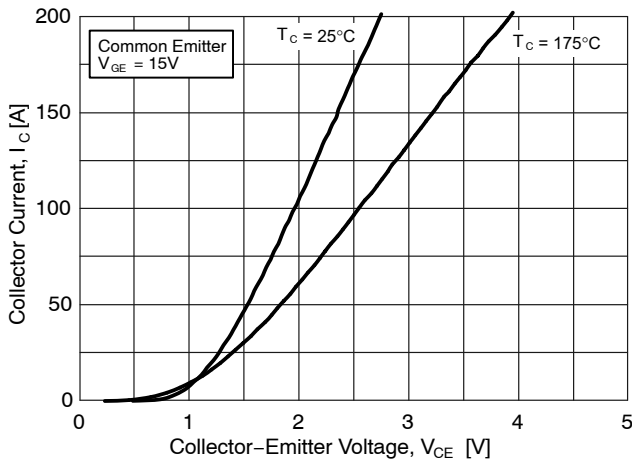


Figure 3. Typical Saturation Voltage

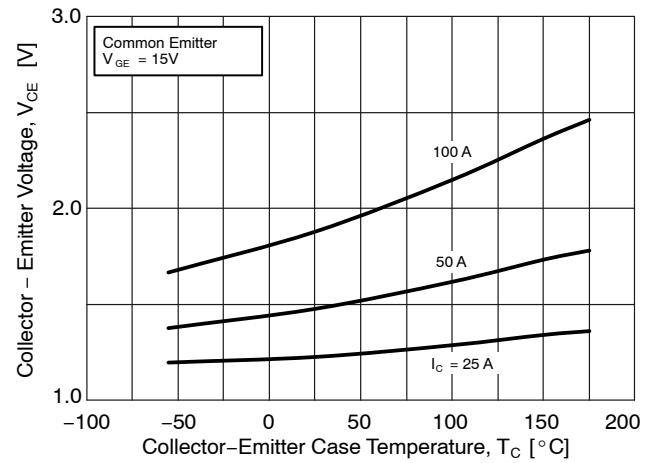


Figure 4. Saturation Voltage vs. Case Temperature

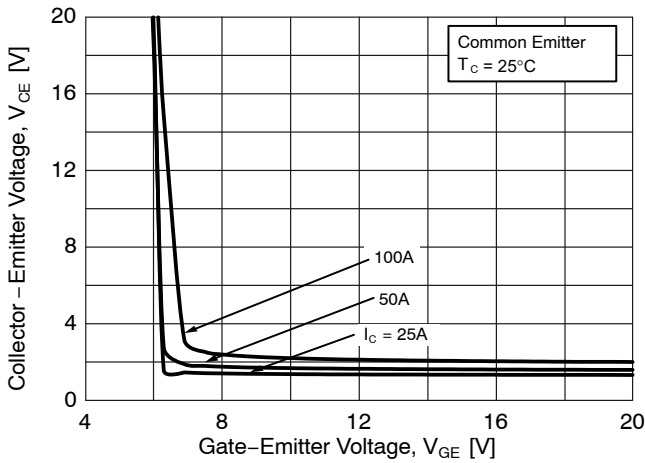


Figure 5. Saturation Voltage vs. V_{GE}

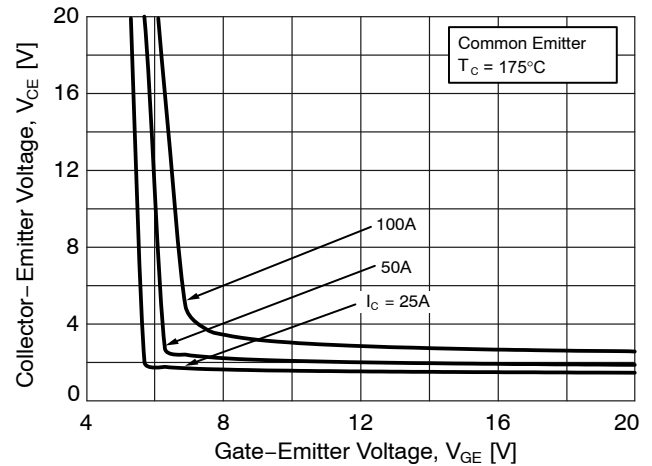


Figure 6. Saturation Voltage vs. V_{GE}

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TYPICAL CHARACTERISTICS

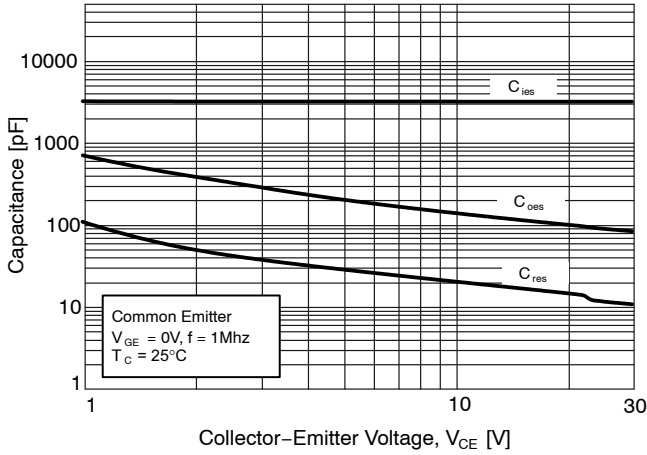


Figure 7. Capacitance Characteristics

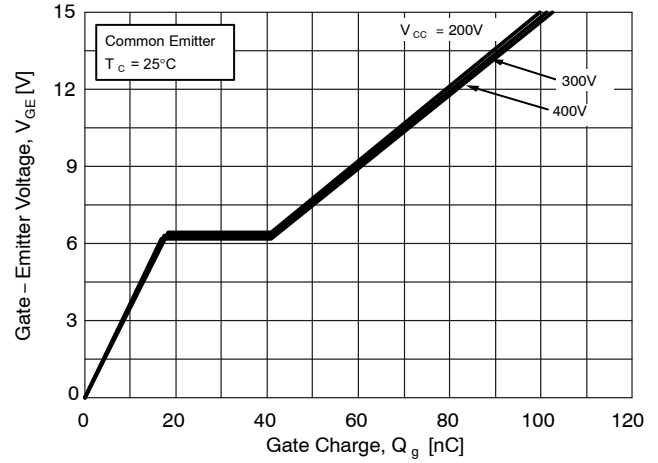


Figure 8. Gate Charge

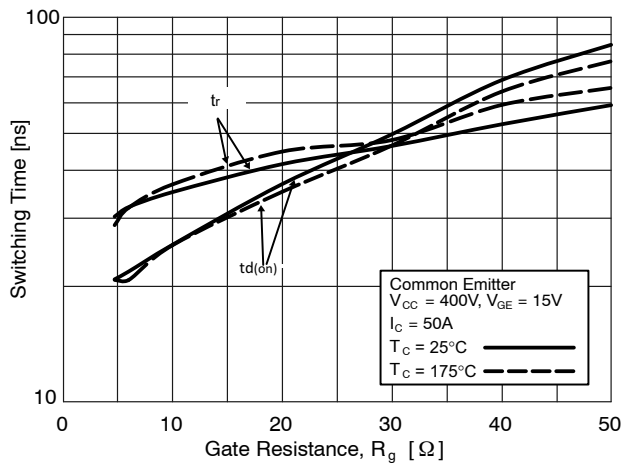


Figure 9. Turn-On Characteristics vs. Gate Resistance

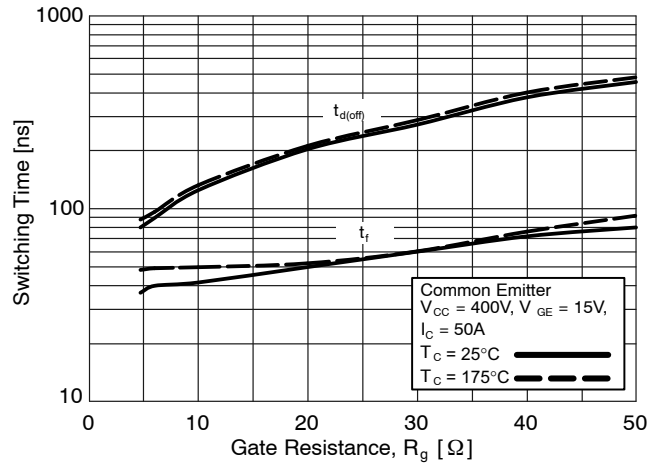


Figure 10. Turn-Off Characteristics vs. Gate Resistance

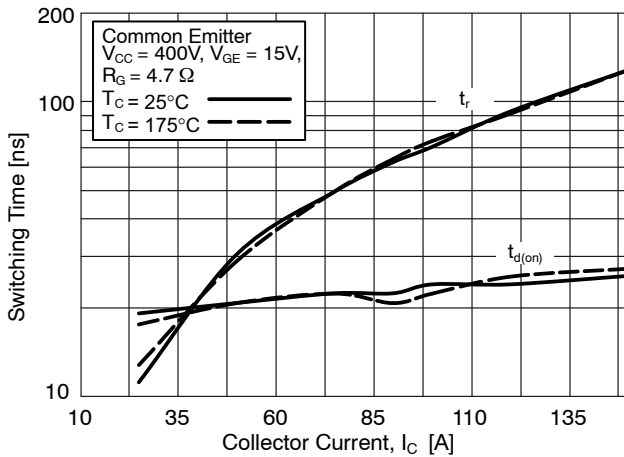


Figure 11. Turn-On Characteristics vs. Collector Current

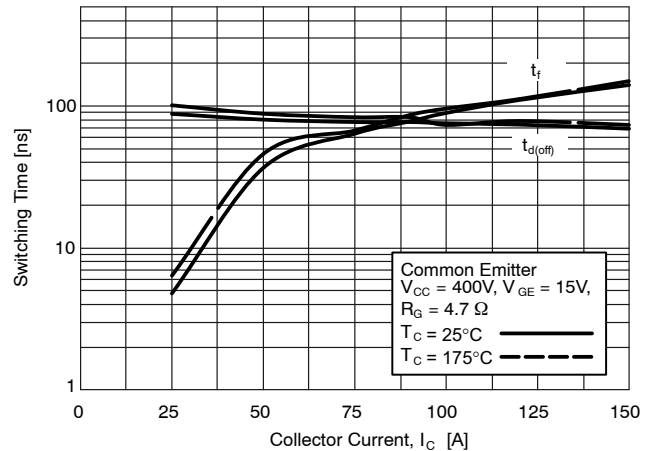


Figure 12. Turn-Off Characteristics vs. Collector Current

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TYPICAL CHARACTERISTICS

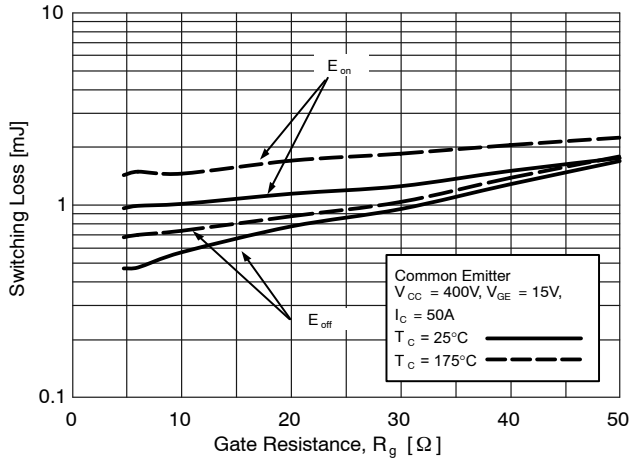


Figure 13. Switching Loss vs. Gate Resistance

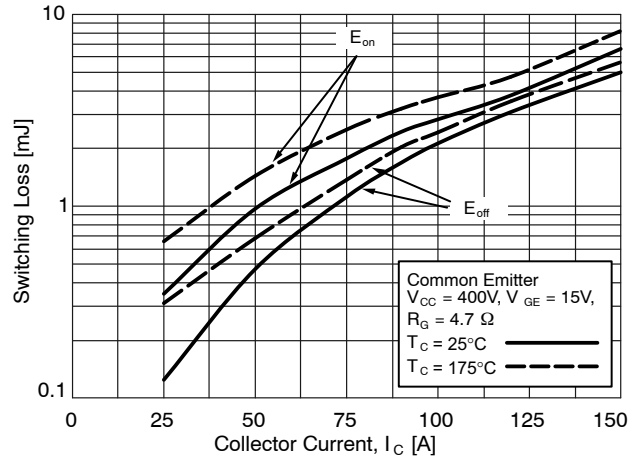


Figure 14. Switching Loss vs. Collector Current

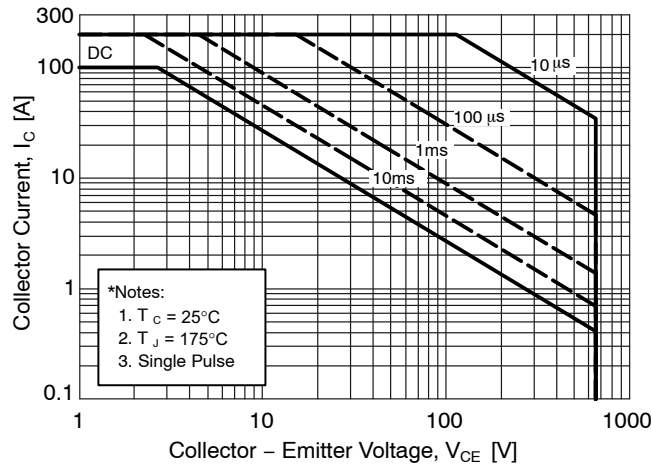


Figure 15. SOA Characteristics

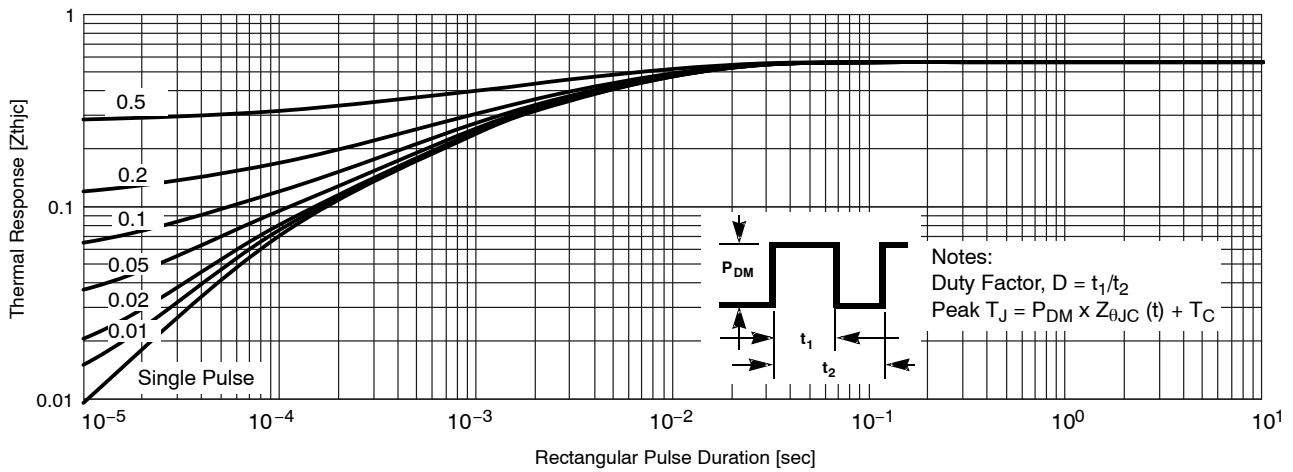


Figure 16. transient Thermal Impedance of IGBT

MECHANICAL CASE OUTLINE

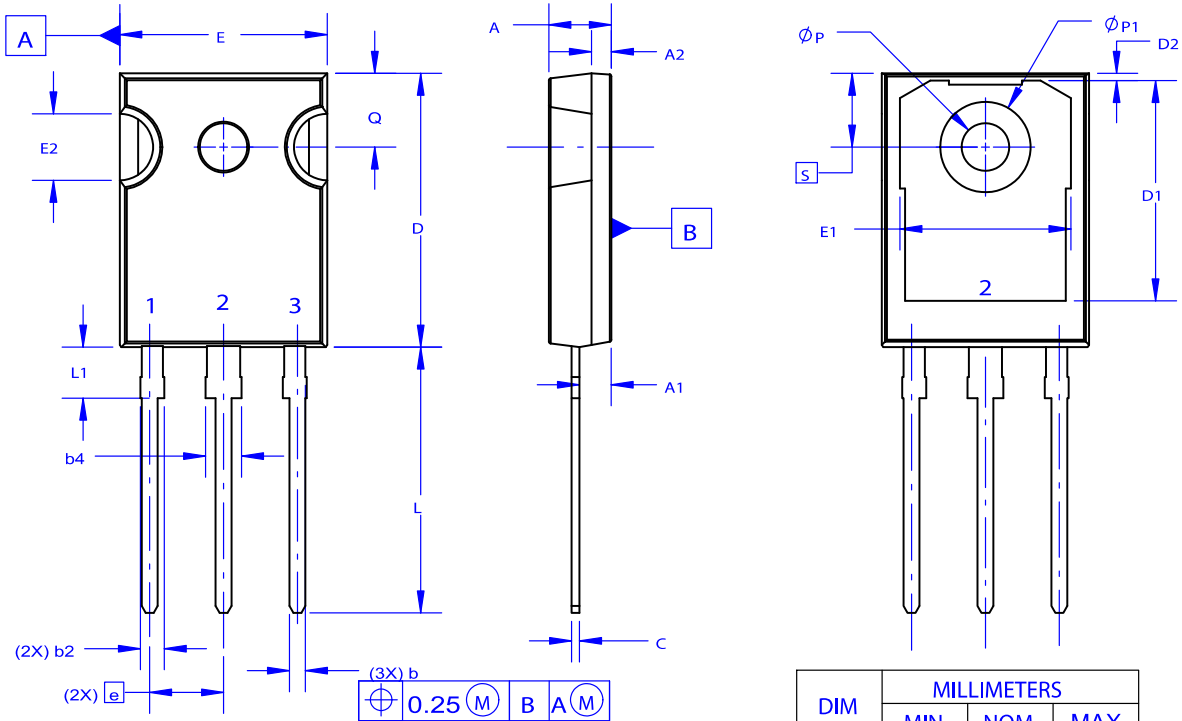
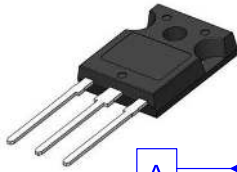
PACKAGE DIMENSIONS

ON Semiconductor®



TO-247-3LD
CASE 340CX
ISSUE A

DATE 06 JUL 2020



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.60	6.80	7.00

GENERIC MARKING DIAGRAM*



- XXXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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